

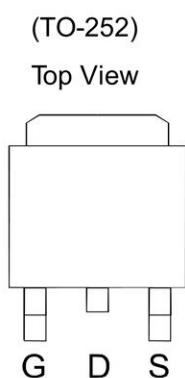
### Features

- $V_{DS} = -30V, I_D = -80A$
- $R_{DS(ON)} \leq 8m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} \leq 11m\Omega @ V_{GS} = -4.5V$

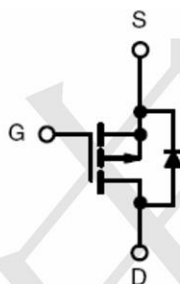
### Application

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable
- Electronics
- Logic Level Shift

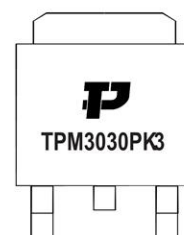
### Package and Pin Configuration



1. GATE
2. DRAIN
3. SOURCE



### Marking:



### Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)

| Parameter                              |                    | Symbol          | Maximum Ratings | Unit       |
|----------------------------------------|--------------------|-----------------|-----------------|------------|
| Drain-Source Voltage                   |                    | $V_{DS}$        | -30             | V          |
| Gate-Source Voltage                    |                    | $V_{GS}$        | $\pm 20$        | V          |
| Continuous Drain Current*              | $T_C = 25^\circ C$ | $I_D$           | -80             | A          |
|                                        | $T_C = 70^\circ C$ |                 | -65             |            |
| Pulsed Drain Current (Package limited) |                    | $I_{DM}$        | -200            | A          |
| Maximum Power Dissipation*             | $T_C = 25^\circ C$ | $P_D$           | 83              | W          |
|                                        | $T_C = 70^\circ C$ |                 | 53              |            |
| Operating Junction Temperature         |                    | $T_J$           | -55 to 150      | $^\circ C$ |
| Thermal Resistance-Junction to Case*   |                    | $R_{\theta JC}$ | 1.5             |            |

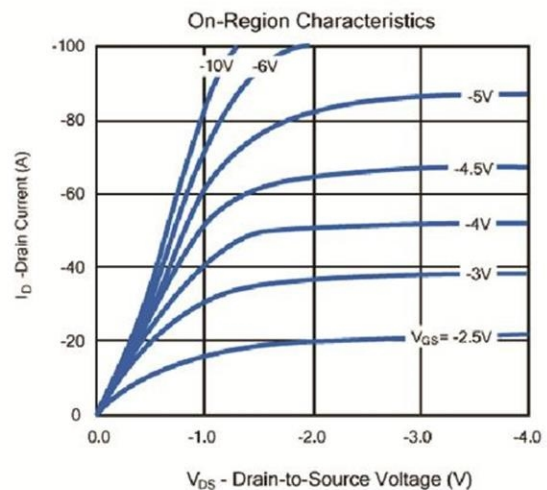
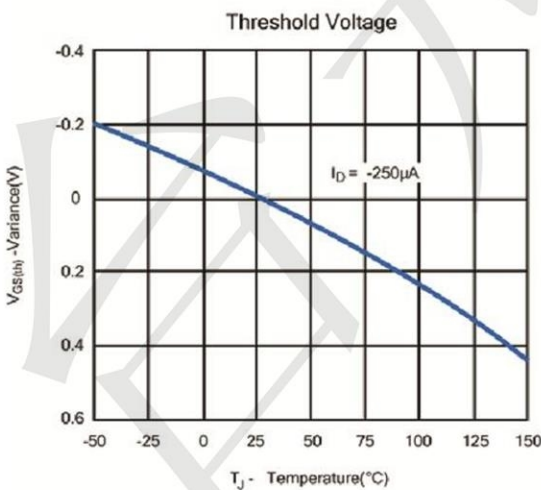
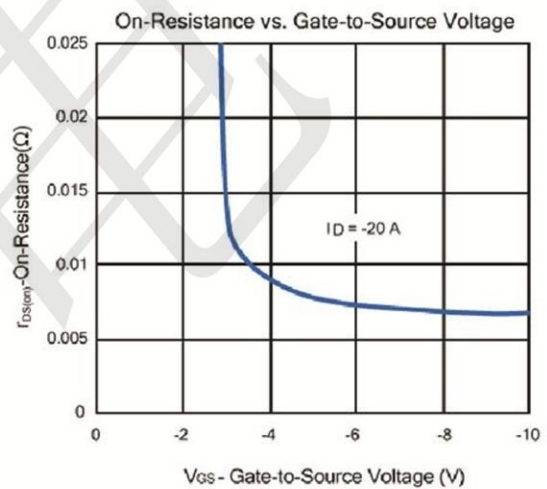
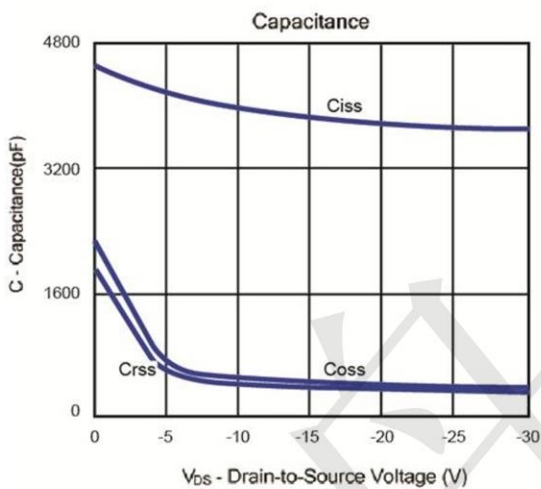
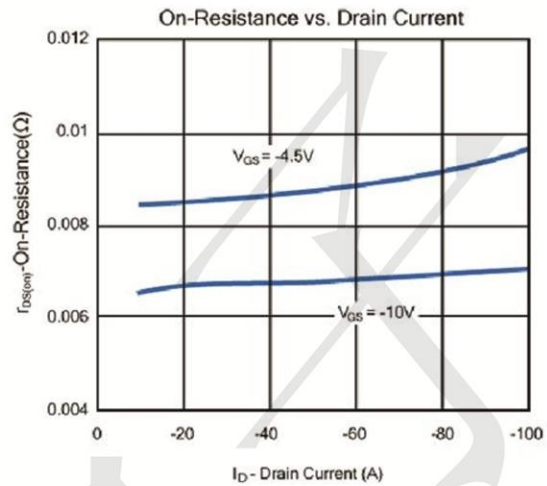
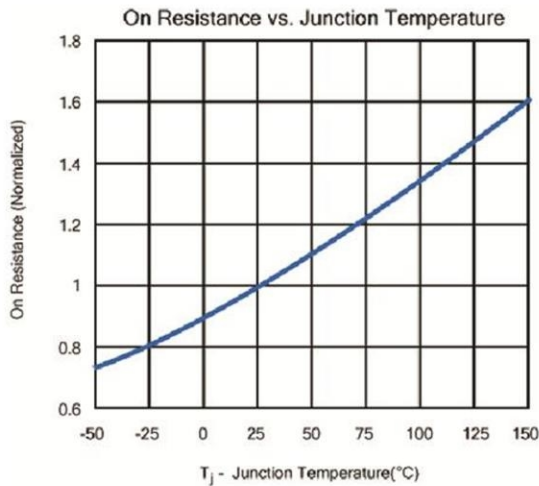
**Electrical Characteristics** (TA=25°C Unless Otherwise Specified)

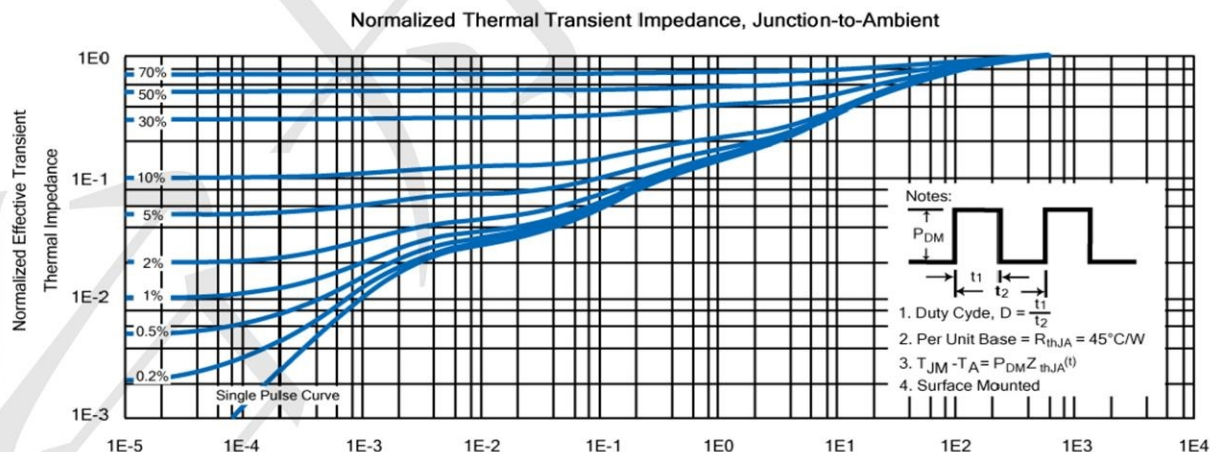
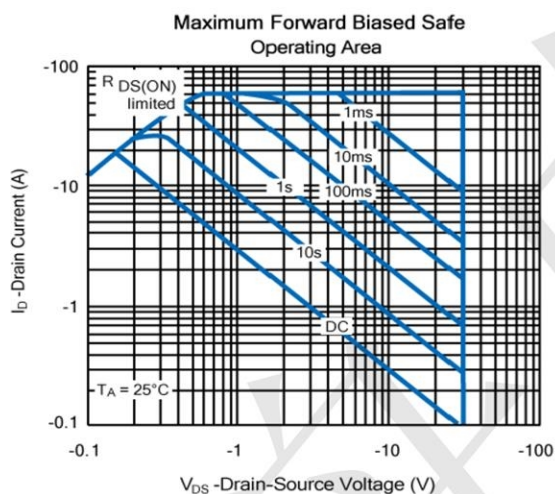
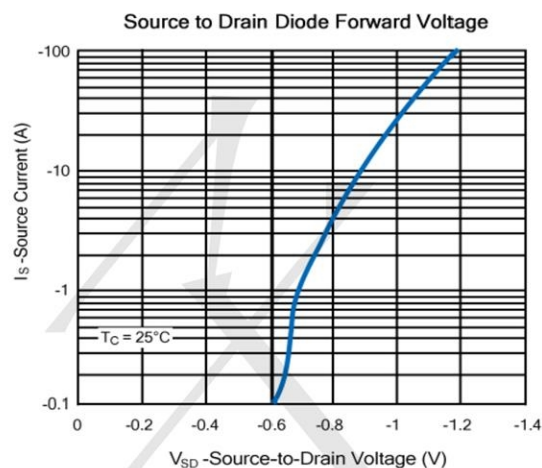
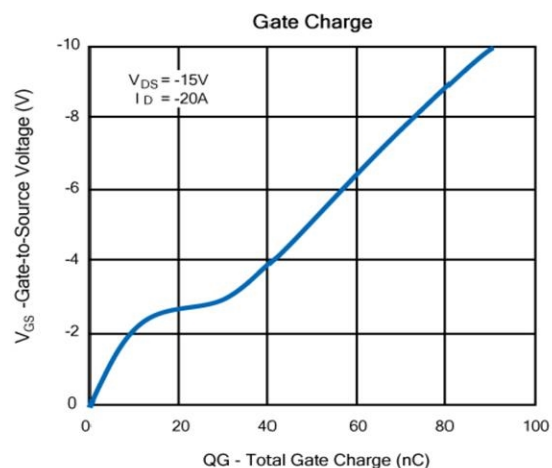
| Symbol               | Parameter                                     | Limit                                                                                                                          | Min | Typ  | Max       | Unit       |
|----------------------|-----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-----|------|-----------|------------|
| <b>STATIC</b>        |                                               |                                                                                                                                |     |      |           |            |
| V <sub>(BR)DSS</sub> | Drain-Source Breakdown Voltage                | V <sub>GS</sub> =0V, I <sub>D</sub> =-250 $\mu$ A                                                                              | -30 |      |           | V          |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage                        | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250 $\mu$ A                                                                | -1  |      | -3        | V          |
| I <sub>GSS</sub>     | Gate Leakage Current                          | V <sub>DS</sub> =0V, V <sub>GS</sub> = $\pm$ 20V                                                                               |     |      | $\pm$ 100 | nA         |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current               | V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V                                                                                     |     |      | -1        | $\mu$ A    |
| R <sub>DS(ON)</sub>  | Drain-Source On-State Resistance <sup>a</sup> | V <sub>GS</sub> =-10V, I <sub>D</sub> = -20A                                                                                   |     | 6.7  | 8         | m $\Omega$ |
|                      |                                               | V <sub>GS</sub> =-4.5V, I <sub>D</sub> = -20A                                                                                  |     | 8.4  | 11        |            |
| V <sub>SD</sub>      | Diode Forward Voltage                         | I <sub>S</sub> =-1A, V <sub>GS</sub> =0V                                                                                       |     | -0.7 | -1.2      | V          |
| <b>DYNAMIC</b>       |                                               |                                                                                                                                |     |      |           |            |
| Q <sub>g</sub>       | Total Gate Charge                             | V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A                                                             |     | 88   |           | nC         |
| Q <sub>g</sub>       | Total Gate Charge                             | V <sub>DS</sub> =-15V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A                                                            |     | 44   |           |            |
| Q <sub>gs</sub>      | Gate-Source Charge                            |                                                                                                                                |     | 12.5 |           |            |
| Q <sub>gd</sub>      | Gate-Drain Charge                             |                                                                                                                                |     | 19.5 |           |            |
| C <sub>iss</sub>     | Input capacitance                             | V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, F=1MHz                                                                             |     | 3887 |           | pF         |
| C <sub>oss</sub>     | Output Capacitance                            |                                                                                                                                |     | 432  |           |            |
| C <sub>rss</sub>     | Reverse Transfer Capacitance                  |                                                                                                                                |     | 372  |           |            |
| t <sub>d(on)</sub>   | Turn-On Delay Time                            | V <sub>DS</sub> =-15V, R <sub>L</sub> =15 $\Omega$<br>V <sub>GS</sub> =-10V, R <sub>G</sub> =6 $\Omega$<br>I <sub>D</sub> =-1A |     | 48   |           | ns         |
| t <sub>r</sub>       | Turn-On Rise Time                             |                                                                                                                                |     | 20   |           |            |
| t <sub>d(off)</sub>  | Turn-Off Delay Time                           |                                                                                                                                |     | 170  |           |            |
| t <sub>f</sub>       | Turn-Off Fall Time                            |                                                                                                                                |     | 54   |           |            |

Notes: a. Pulse test: pulse width  $\leq$  300 $\mu$ s, duty cycle  $\leq$  2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

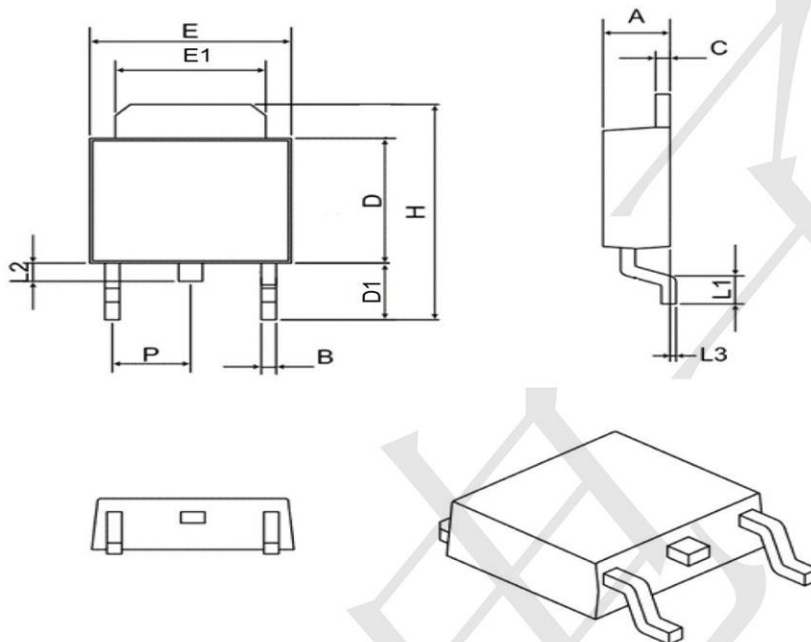
## Typical Characteristics





**Figure 11 Normalized Maximum Transient Thermal Impedance**

## TO252 Package Information



| SYMBOL | MIN      | MAX   |
|--------|----------|-------|
| A      | 2.10     | 2.50  |
| B      | 0.40     | 0.90  |
| C      | 0.40     | 0.90  |
| D      | 5.30     | 6.30  |
| D1     | 2.20     | 2.90  |
| E      | 6.30     | 6.75  |
| E1     | 4.80     | 5.50  |
| L1     | 0.90     | 1.80  |
| L2     | 0.50     | 1.10  |
| L3     | 0.00     | 0.20  |
| H      | 8.90     | 10.40 |
| P      | 2.30 BSC |       |